

SEMiX® 5

Trench IGBT Modules

Evaluation Sample SEMiX155GD12T4

Target Data

Features

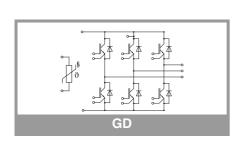
- Solderless assembling solution with PressFIT signal pins and screw power terminals
- IGBT 4 Trench Gate Technology
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Reliable mechanical design with injection moulded terminals and reliable internal connections
- UL recognized file no. E63532
- NTC temperature sensor inside

Typical Applications*

- · AC inverter drives
- UPS
- Electronic Welding

Remarks

- Product reliability results are valid for $T_{\text{jop}}{=}150^{\circ}\text{C}$
- · Dynamic data are estimated
- For storage and case temperature with TIM see document "TP(HALA P8) SEMiX 5p"



Absolute Maximum Ratings							
Symbol	Conditions		Values	Unit			
IGBT	•		'				
V _{CES}	T _j = 25 °C		1200	V			
I _C	T _j = 175 °C	T _c = 25 °C	219	Α			
		T _c = 80 °C	169	А			
I _{Cnom}			150	Α			
I _{CRM}	$I_{CRM} = 3xI_{Cnom}$		450	Α			
V_{GES}			-20 20	V			
t _{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \le 20 \text{ V}$ $V_{CES} \le 1200 \text{ V}$	T _j = 150 °C	10	μs			
T _j			-40 175	°C			
Inverse d	iode						
V_{RRM}	T _j = 25 °C		1200	V			
I _F	T _i = 175 °C	T _c = 25 °C	175	А			
	71,-175 0	T _c = 80 °C	131	Α			
I _{Fnom}			150	Α			
I _{FRM}	I _{FRM} = 2xI _{Fnom}		300	Α			
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		900	Α			
Tj			-40 175	°C			
Module							
I _{t(RMS)}			280	Α			
T _{stg}	module without TIM		-40 125	°C			
V _{isol}	AC sinus 50Hz, t = 1 min		4000	V			

Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
IGBT							
$V_{\text{CE(sat)}}$	I _C = 150 A	T _j = 25 °C		1.80	2.05	V	
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.20	2.40	V	
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V	
		T _j = 150 °C		0.70	0.80	V	
	V _{GE} = 15 V	T _j = 25 °C		6.7	7.7	mΩ	
	chiplevel	T _j = 150 °C		10.0	11	mΩ	
$V_{GE(th)}$	$V_{GE}=V_{CE}$, $I_{C}=6$ mA		5	5.8	6.5	V	
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 12$	00 V, T _j = 25 °C			2.0	mA	
C _{ies}	V 05.V	f = 1 MHz		9.3		nF	
Coes	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		0.58		nF	
C _{res}		f = 1 MHz		0.51		nF	
Q_G	V _{GE} = - 15 V+ 15 V			850		nC	
R _{Gint}	T _j = 25 °C			5.0		Ω	
t _{d(on)}	di/dt _{on} = 3300 A/μs	T _j = 150 °C		t.b.d.		ns	
t _r		T _j = 150 °C		t.b.d.		ns	
E _{on}		T _j = 150 °C		13		mJ	
t _{d(off)}		T _j = 150 °C		t.b.d.		ns	
t _f		T _j = 150 °C		t.b.d.		ns	
E _{off}	di/dt _{off} = 1000 A/μs	T _j = 150 °C		21		mJ	
R _{th(j-c)}	per IGBT				0.21	K/W	
R _{th(c-s)}	per IGBT (λgrease=0.81 W/mK, thickness 50-100μm)			t.b.d.		K/W	
R _{th(c-s)}	per IGBT (λ=3.4 W/mK)			t.b.d.		K/W	



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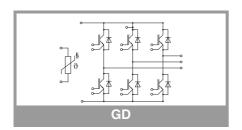
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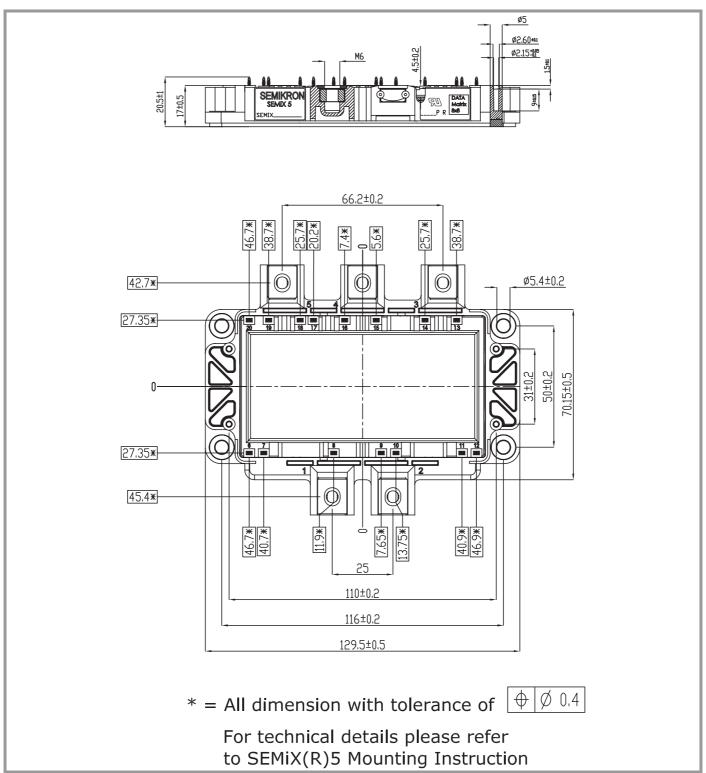
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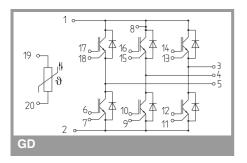
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Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse d	iode					•
$V_F = V_{EC}$	I _F = 150 A	T _j = 25 °C		2.14	2.46	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		2.07	2.38	V
V_{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V
		T _j = 150 °C		0.90	1.10	V
r _F	chiplevel	T _j = 25 °C		5.6	6.4	$m\Omega$
		T _j = 150 °C		7.8	8.5	mΩ
I _{RRM}	I _F = 150 A	T _j = 150 °C		-		Α
Q _{rr}	di/dt _{off} = 3300 A/μs V _{GE} = -15 V	T _j = 150 °C		-		μC
E _{rr}	V _{GE} = -13 V V _{CC} = 600 V	T _j = 150 °C		14		mJ
R _{th(j-c)}	per diode				0.35	K/W
R _{th(c-s)}	per diode (λgrease=0.81 W/mK, thickness 50-100μm)			t.b.d.		K/W
R _{th(c-s)}	per diode (λ=3.4 W/mK)			t.b.d.		K/W
Module	•					•
L _{CE}				20		nΗ
R _{CC'+EE'}	measured per	T _C = 25 °C		1.2		mΩ
	switch	T _C = 125 °C		1.65		mΩ
Rth _{(c-s)1}	calculated without thermal coupling			t.b.d.		K/W
Rth _{(c-s)2}	including thermal coupling, Ts underneath module $(\lambda_{grease}=0.81 \text{ W/} (\text{m}^{\star}\text{K}))$			t.b.d.		K/W
Rth _{(c-s)2}	including thermal coupling, Ts underneath module, pre-applied phase change material			t.b.d.		K/W
Ms	to heat sink (M5)		3		6	Nm
Mt		to terminals (M6)	3		6	Nm
]					Nm
W				398		g
Temperat	ure Sensor					_
R ₁₀₀	T _c =100°C (R ₂₅ =5 kΩ)			493 ± 5%		Ω
B _{100/125}	$R_{(T)}=R_{100}exp[B_{100/125}(1/T-1/T_{100})];T[K];$			3550 ±2%		К





SEMiX5p



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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